

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT7495202

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YUEH-MING LIU	08/18/2022
HSIAO-CHUNG CHEN	08/16/2022
CHIA-WEI CHEN	08/17/2022
YU-HSIANG HUANG	08/16/2022
CHIA-CHE CHANG	08/15/2022
HUA-KAI TONG	08/15/2022
TAN-HSIN CHANG	08/18/2022
YU-CHUAN CHANG	08/18/2022
MING-YU CHEN	08/18/2022
YU-YEN HSIUNG	08/14/2022
KUN-CHIEH LIAO	08/15/2022
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SUPER MICRO COMPUTER, INC.
<b>Street Address:</b>	980 ROCK AVENUE
<b>City:</b>	SAN JOSE
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95131
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17891563
<b>CORRESPONDENCE DATA</b>	
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<b>Phone:</b>	6508421300
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<b>Address Line 1:</b>	P.O. BOX 51887
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<b>ATTORNEY DOCKET NUMBER:</b>	SMICP021
<b>NAME OF SUBMITTER:</b>	PATRICK D. BENEDICTO
<b>SIGNATURE:</b>	/Patrick D. Benedicto/
<b>DATE SIGNED:</b>	08/19/2022
<b>Total Attachments: 2</b> source=SMICP021_Assignment.docx#page1.tif source=SMICP021_Assignment.docx#page2.tif	

## ASSIGNMENT OF PATENT APPLICATION

Whereas I, an undersigned inventor, have invented certain new and useful improvements as set forth in the patent application entitled:

### FLUID IMMERSION COOLING SYSTEM WITH LOW FLASH POINT HYDROCARBON DIELECTRIC FLUID


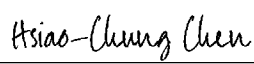
(Atty. Docket No. SMICP021), (check one)

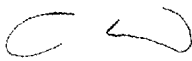
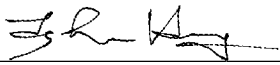
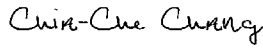

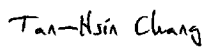
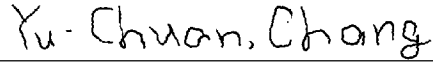

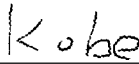
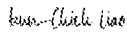
- ☐ for which I have executed a U.S. patent application on even date herewith. (Accompanying)  
☐ which bears U.S. Application No. 17/891,563. (Not accompanying)  
☐ which is a U.S. provisional application. (Accompanying)

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, an undersigned inventor, hereby:

- 1) Sell, assign and transfer to Super Micro Computer, a Delaware corporation having a place of business at 980 Rock Avenue, San Jose, California, 95131 ("ASSIGNEE"), the entire right, title and interest in any and all improvements and inventions disclosed in, applications based upon, and patents granted upon (including foreign patents and the right to claim priority), the above-referenced application.
- 2) Authorize and request the Commissioner of Patents to issue any and all United States Patents resulting from said application or any division, continuation, substitute, renewal, re-examination or reissue thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representatives, and shall be binding upon the inventor, as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that I have not entered and will not enter into any assignment, contract, or understanding that conflicts with this assignment.
- 6) Authorize and request my attorney/agent to insert above the Application No. in order to assist with recordal of this assignment.

Signed on the date indicated beside my signature.

- |    |   |                        |
|----|---|------------------------|
| 1) | Signature: <u></u> | Date: <u>8/18/2022</u> |
|    | Typed Name: Yueh-Ming LIU   |                        |
| 2) | Signature: <u></u> | Date: <u>8/16/2022</u> |
|    | Typed Name: Hsiao-Chung CHEN  |                        |

- 3) Signature:  Date: 8/17/2022  
Typed Name: Chia-Wei CHEN
- 4) Signature:  Date: 8/16/2022  
Typed Name: Yu-Hsiang HUANG
- 5) Signature:  Date: 8/15/2022  
Typed Name: Chia-Che CHANG
- 6) Signature:  Date: 8/15/2022  
Typed Name: Hua-Kai TONG
- 7) Signature:  Date: 8/18/2022  
Typed Name: Tan-Hsin CHANG
- 8) Signature:  Date: 8/18/2022  
Typed Name: Yu-Chuan CHANG
- 9) Signature:  Date: 8/18/2022  
Typed Name: Ming-Yu CHEN
- 10) Signature:  Date: 8/14/2022  
Typed Name: Yu-Yen HSIUNG
- 11) Signature:  Date: 8/15/2022  
Typed Name: Kun-Chieh LIAO